

# STUDY OF SELF-DIFFUSION IN SEMICONDUCTORS BY STATISTICAL MOMENT METHOD

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**Abstracts.** Using the statistical moment method, self-diffusion in semiconductors is studied including the anharmonic effects of lattice vibrations. The interaction energies between atoms in semiconductors are estimated by applying many-body potential. The activation energy  $Q$  and pre-exponential factor  $D_0$  of the self-diffusion coefficient are given in closed forms. The values of  $Q$  and  $D_0$  are calculated for Si and GaAs at high temperature region near the melting temperatures and they shown to be in good agreement with the experimental data

## 1. Introduction

The physical properties of crystalline solids, like electrical conductivity, atomic diffusivity and mechanical strength are generally influenced quite significantly by the presence of lattice defects [1]. The point defects like the vacancies and interstitials, play an important role in determining the atomic diffusions in crystals [2]. It is known that the self-diffusion in close-packed crystals is almost completely conducted by the thermal lattice vacancies. On the other hand, the mechanical properties of the materials, e.g., creep, aging, recrystallization, precipitation hardening and irradiation effects (void swelling), are also extensively controlled by atomic diffusions [1]. Therefore, it is of great significance to establish a theoretical scheme for treating atomic diffusion in crystalline solids.

The theory of atomic diffusion in solids has a long history. In 1905, Einstein used incidental chaotic model for investigating the diffusion [3]. Bardeen và Hering improved this model so as to include the correlation effect [4]. Using the transition state theory [5], Glestom et al. have derived the diffusion coefficient and showed that the self-diffusion obeys the Arrhenius's law. Kikuchi discussed the atomic diffusion in metals and alloys by applying the path probability method [6]. In general, the atomic diffusion have been studied within the framework of the phenomenological theories and based on the simple theory of the thermal lattice vibrations. In the present study, we establish a theoretical scheme to treat the self-diffusion in semiconductors taking into account the anharmonicity of lattice vibrations. We use the moment method in statistical dynamics in order to calculate the pre-exponential factor  $D_0$  and the activation energy  $Q$  for self-diffusion in semiconductor with diamond cubic and zincblende ZnS structures. We compare the calculated results of self-diffusion in semiconductors with the experimental data.

## 2. Theory of self-diffusion in semiconductors

In the case of the self-diffusion conducted by a vacancy mechanism, it has been generally assumed that the diffusion coefficient  $D$  is simply given as

$$D = av \exp [- Q/ RT], \quad Q = g_v^f + g_v^m, \quad (1)$$

where  $a$  and  $v$  are the jump distance and attempt frequency of the atom, respectively. The activation energy  $Q$  of the self-diffusion is the sum of the changes in the free energy for the formation  $g_v^f$  and migration  $g_v^m$  of the vacancy.

In this paper, we investigate the self-diffusion in semiconductors by using the moment method in statistical dynamics. We consider the self-diffusion via vacancy mechanism and do not take into account the contribution from di-vacancies and direct atomic exchange mechanisms. We take into account the global lattice expansion originated from the anharmonicity of thermal lattice vibrations, but do not consider the detailed local lattice relaxation around the vacancies. In order to study the atomic diffusion in semiconductors, one must firstly determine the equilibrium lattice spacing and the free energy of the perfect crystal because the atomic diffusion occur at finite temperatures. The calculational procedure for obtaining thermodynamic quantities of the perfect crystals has been given in our previous studies [7,8]. We then derive the thermodynamic quantities of the crystal containing thermal lattice vacancies, which play a central role in the self-diffusion of semiconductors.

Let us consider a monoatomic crystal consisting of  $N$  atoms and  $n$  lattice vacancies. By assuming  $N \gg n$  the Gibbs free energy of the crystal is given as

$$G(T, p) = G_0(T, p) + n g_v^f(T, p) - TS_c, \quad (2)$$

where  $T$  and  $p$  denote the absolute temperature and hydrostatic pressure, respectively.  $G_0(T, p)$  is the Gibbs free energy of perfect crystal of  $N$  atoms,  $g_v^f(T, p)$  is the change in the Gibbs free energy due to the formation of a single vacancy and  $S_c$  is the entropy of mixing

$$S_c = k_B \ln \frac{(N + n)!}{N!n!}$$

where  $k_B$  denotes the Boltzmann constant. It is noted here that  $g_v^f(T, p)$  contains contribution from vibrational entropy of the system.

The equilibrium concentration of a vacancy  $n_v$  in semiconductors can be calculate from the Gibbs free energy of the system. To obtain the equilibrium concentration  $n_v$ , we use the minimization condition of the free energy with respect to  $n_v$  under the condition of constant  $p$ ,  $T$  and  $N$  as

$$(\partial G / \partial n_v)_{p, T, N} = 0. \quad (4)$$

This minimization condition leads to the concentration of the vacancy as

$$n_v = \exp \left[ \frac{g_v^f(T, p)}{\theta} \right] \quad (5)$$

with  $\theta = k_B T$ . Then, the Gibbs free energy of the crystal containing equilibrium thermal vacancies can be given by

$$g_v^f \cong - (n_1 + n_2) \psi_0^* + n_1 \psi_1^* + n_2 \psi_2^* + \Delta \psi_0^*, \quad (6)$$

where

$$\psi_0^* = 3 \{ U_0 / 6 + \theta [x + \ln (1 - e^{-2x})] \}, \quad (7a)$$

$$U_0 = \sum \varphi_{0i} (|\mathbf{r}_i|), \quad (7b)$$

$$\mathbf{r}_i = \mathbf{r}_0 + \Delta \mathbf{r}_i. \quad (7c)$$

Here,  $x = \hbar \omega / 2\theta$ ,  $\omega$  denotes the atomic vibrational frequency,  $n_1$  and  $n_2$  denote numbers of the first and second nearest-neighbours, respectively.  $\psi_0^* = \psi_0 / N$  denotes the Helmholtz free energy per single atom in the perfect crystal [6],  $\psi_1^*$  and  $\psi_2^*$  represent the free energy of the atoms located at the nearest-neighbour and next nearest-neighbour sites of the vacancy, respectively,  $\varphi_{0i}$  is the interaction energy between zeroth and  $i$ -th atoms,  $\mathbf{r}_i$  indicates the position of the  $i$ -th atom located at the neighbouring sites of the central 0-th atom or the nearest distance of the  $i$ -th atom at temperature  $T$ ,  $\mathbf{r}_0$  determines the nearest distance of the  $i$ -th atom at temperature 0K,  $\Delta \mathbf{r}_i$  indicates the displacement of the  $i$ -th atom from the equilibrium position at temperature  $T$  or the thermal expansion depending on temperature of lattice and it is determined as in [9]. It must be noted that we take into account the anharmonicity of the thermal lattice vibration and therefore the temperature dependent thermal lattice expansion and vibrational force constants are considered.

To calculate the interaction energy  $U_0$  of the perfect crystal, we use the empirical pair potentials and take into account the contributions up to the second nearest-neighbours.  $\Delta \psi_0^*$  denotes the change in the Helmholtz free energy of the central atom which creates a vacancy by moving itself to the certain sinks (e.g., crystal surface, or to the core region of the dislocation and grain boundary) in the crystal

$$\Delta \psi_0^* = \psi_0^{*'} - \psi_0^* \equiv (B - 1) \psi_0^*, \quad (8)$$

where  $\psi_0^{*'}$  denotes the free energy of the central atom after moving to a certain sink sites in the crystal. In this respect, it is noted that the vacancy formation energies

of the real crystals are measured experimentally as an average value over all those values corresponding to the possible sink sites.

In the theoretical analysis, it has been often assumed that the central atom originally located at the "vacancy site" moves to the special atomic sites, i.e., kink sites on the surface or in the core region of the edge dislocation in the bulk crystal which are thermodynamically equivalent to bulk atoms [10]. This assumption simply leads to  $B = 1$  in the above eq. (8). In the present study, we take the average value for  $B$  as

$$B \approx \frac{1}{2} + \frac{-(1 + n_1 + n_2)\psi_0^* + n_1\psi_1^* + n_2\psi_2^*}{-2\psi_0^*} \quad (9)$$

This is equivalent to the condition that the half of the broken bonds are recovered at the sink sites. We do not take into account the lattice relaxation around a vacancy, because the change in the free energy due to the lattice relaxation is a minor contribution compared to the formation energy of a vacancy, especially for high temperature region near the melting temperature.

We now derive the thermodynamic quantities of the semiconductor lattice containing thermal vacancies and discuss the self-diffusion via vacancy mechanism. From (2), the Gibbs free energy of the semiconductor lattice containing thermal vacancies can be written in the form

$$G = H - TS, \quad (10)$$

where  $S = -(\partial G / \partial T)_p$  is the entropy and  $H$  represents the enthalpy of the system. Thus, the change in the Gibbs free energy  $g_v^f$  due to the creation of a vacancy can be written as

$$g_v^f(T,p) = G(T,p) - G_0(T,p) = h_v^f(T,p) - TS_v^f(T,p), \quad (11)$$

where  $h_v^f$  and  $S_v^f$  are the enthalpy and entropy of formation of a vacancy.

The diffusion coefficient  $D$  of the semiconductor lattice can be obtained by assuming that it is proportional to the vacancy concentration  $n_v$  and the jump frequency  $\Gamma$  [2]. When the amplitude of the atomic vibration exceeds certain critical value in the nearest neighbour sites of the vacancy, one can expect that atomic exchange process with a vacancy occurs. The number of jumps  $\Gamma^*$  per unit time is proportional to the vibrational frequency of the atom  $\omega$  and the square of the diffusion length  $a$  (or distance of jumping)

$$\Gamma^* \sim r_i^2 \omega / (2\pi) = (r_0 + \Delta r_i)^2 \omega / (2\pi). \quad (12)$$

The general expression of diffusion coefficient  $D$  can then be written in the form

$$D = g\Gamma n_v a^2, \quad (13)$$

where  $g$  is a coefficient which depends on the crystalline structure and the mechanism of self-diffusion. It is given with the correlation factor  $f$  as

$$g = n_1 f. \quad (14)$$

The attempt frequency  $\Gamma$  of the atomic jump is proportional to  $\Gamma^*$  and the transition probability of an atom

$$\Gamma = \frac{\omega}{2\pi} \exp\left(\frac{\Delta\psi_1^*}{\theta}\right), \quad (15)$$

The change in the Gibbs free energy associated with the exchange of the vacancy with the neighbouring atoms is equal to the inverse sign of  $\Delta\psi_1^*$  and

$$g_v^m = -\Delta\psi_1^* = -(B' - 1)\psi_1^*. \quad (16)$$

where  $B'$  is simply regarded as a numerical factor, which is analogous to the factor  $B$  defined for formation energy of the vacancy.

Summarizing eqs. (12)-(16), one can derive the diffusion constant  $D$  of semiconductors via the vacancy mechanism as

$$D = n_1 f \frac{\omega}{2\pi} a^2 \exp\left(-\frac{h_v^f - \Delta\psi_1^*}{\theta}\right) \exp\left(\frac{TS_v^f}{\theta}\right) \quad (17)$$

The above formula of the diffusion coefficient can be rewritten as

$$D = D_0 \exp\left(-\frac{Q}{k_B T}\right), \quad Q = h_v^f + h_v^m, \quad D_0 = n_1 f \frac{\omega}{2\pi} a^2 \exp\left(\frac{S_v^f}{k_B}\right), \quad (18)$$

where the correlation factor of the self-diffusion  $f = 0,5$  [14] for semiconductors with diamond cubic and zincblende structures and the activation energy  $Q$  is given by

$$Q = -(n_1 + n_2)\psi_0^* + n_1\psi_1^* + n_2\psi_2^* + (B - 1)\psi_0^* - (B' - 1)\psi_1^* + p\Delta V. \quad (19)$$

It is noted here that the contribution from the entropy of migration  $S_v^m$  is included in the  $-(B' - 1)\psi_1^*$  term, and not separated as  $S_v^f$  in eq.(18). On the other hand, the entropy  $S_v^f$  for the formation of a vacancy can be given in the next-nearest neighbour approximation as

$$S_v^f = \frac{1}{n_1 + n_2} k_B \ln \frac{(N+1)!}{N!} = \frac{k_B}{n_1 + n_2} \ln(N+1) \quad (20)$$

With the use of eqs.(18)-(20) one can determine the activation energy  $Q$  and the diffusion coefficients  $D_0$  at temperature  $T$  and pressure  $p$ .

In the following section we shall use the above results for finding the diffusion coefficient  $D_0$ , the activation energy  $Q$  for Si and GaAs semiconductors and compare them with experimental data.

### 3. Results of numerical calculations and discussions

Recently the theorists developed extensively the interaction potentials between atoms in the form of simple model in order to calculate directly the structural and thermodynamic properties for complex systems, especially for semiconductors [11,12]. The pair potentials like the Lennard-Jones potential and the Morse potential have been applied to study the inert gas, metal and ion crystal, but completely used to the strong valence systems like semiconductors. To study the valence systems it is necessary to use the many-body interaction potentials, e.g., the potentials were presented by Stillinger, Weber [11], Tersoff [12]. One of the empirical many-body potentials for Si has the following form [13]

$$\begin{aligned}\Phi &= \sum_{i<j} U_{ij} + \sum_{i<j<k} W_{ijk} \\ U_{ij} &= \varepsilon \left[ \left( \frac{r_0}{r_{ij}} \right)^{12} - 2 \left( \frac{r_0}{r_{ij}} \right)^6 \right], \\ W_{ijk} &= G \frac{1 + 3 \cos \theta_i \cos \theta_j \cos \theta_k}{(r_{ij} r_{jk} r_{ki})^3}\end{aligned}\quad (21)$$

This potential firstly is parameterized for Si. The parameters are fitted in with the cohesive length of dimer and trimer, the lattice parameter and the cohesive energy of the diamond structure. Same potentials are expanded for the systems of two components and three components like GaAs, SiAs, SiGa, SiGaAs,...

Applying the many-body potentials (21), we calculate the nearest-neighbour interaction and the next-nearest-neighbour interaction and take the interaction energy in semiconductors as

$$U_0 = \varepsilon \left[ A_{12} \left( \frac{r_0}{r_1} \right)^{12} - 2A_6 \left( \frac{r_0}{r_1} \right)^6 \right] + \frac{0.078n_1G_1}{r_1^9} + \frac{1.375n_2G_2}{(v_2r_1)^9}, \quad (22)$$

where  $A_6, A_{12}$  are the structural sums for semiconductor.

The nearest neighbour distance  $r_1(0)$  at temperature  $T = 0K$  is obtained by minimizing the total energy of semiconductor or taking derivative

$$(\partial U_0 / \partial r) = 0 \quad (23)$$

and is equal to

$$R_1(0) = \left[ \frac{2\epsilon A_{12} r_0^{12}}{(\Delta^2 + 4A_6 A_{12} \epsilon^2 r_0^{18})^{1/2} - \Delta} \right]^{1/3} \quad (24)$$

$$\Delta = 0.234G_1 + 0.0898G_2. \quad (25)$$

Using the experimental data for Si and GaAs ( Table 1) and the formulae in the previous section, we obtain the values of the activation energy Q, the pre-exponential factor D<sub>0</sub> at various temoeratures for Si and GaAs. The numerical calculations are summirized in Tables 2 and 3. It is noted that the theoretical results can apply to GaAs though the analysis is more complex because of non-equal masses of atoms in the structure of ZnS type

**Table 1:** The parameters of the many-body potential for Si and GaAs [13 ]

Quantities	Si	GaAs
$\epsilon_A$ ( eV)	2.817	
$r_{0AA}$ (Å)	2.295	
$G_{AAA}$ (eV.Å <sup>9</sup> )	3484	
$\epsilon_{AB}$ (eV)		1.738
$r_{0AB}$ (Å)		2.448
$G_{AAB}$ (eV. Å <sup>9</sup> )		1900
$G_{ABB}$ (eV. Å <sup>9</sup> )		4600

**Table 2:** The activation energy Q and the pre-exponential factor D<sub>0</sub> for Si

T(K)	200	400	600	800	1000	1200	1400
Q(kcal/mol)	85.95	87.56	89.21	90.88	92.565	94.25	95.96
D0(10 <sup>-4</sup> m <sup>2</sup> /s)	6.18	6.55	6.95	7.24	7.44	7.58	7.72
a(Å )	5.1745	5.1840	5.1922	5.2001	5.2078	5.2162	5.2262

**Table 3:** The activation energy Q and the pre-exponential factor D<sub>0</sub> for GaAs

T(K)	200	400	600	800	1000	1200
Q(kcal/mol)	57.26	58.81	60.44	62.45	65.47	69.70
D <sub>0</sub> (10 <sup>-1</sup> m <sup>2</sup> /s)	3.83	4.09	4.64	-	-	-
a(Å)	5.5861	5.6002	5.6261	5.6767	5.7748	5.9389

For Si, from experimental data Q = 110 kcal/mol, D<sub>0</sub> = 1.8. 10<sup>-4</sup>m<sup>2</sup>/s [15], Q = 107.05 kcal/mol in the interval from 1128K to 1448K and Q = 109.82 kcal/mol in

the interval from 1473K to 1673K[16]. Therefore, the calculation results coincide relatively well with the experiment data.

For GaAs, from experimental data  $Q = 59.86$  kcal/mol in the interval from 1298K to 1373K and  $Q = 128.92$  kcal/mol in the interval from 1398K to 1503K[16]. The numerical results also agree relatively well with experiments. Both the activation energy and the diffusion coefficient for Si and GaAs increases when the temperature increases and this coincides with experiments.

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